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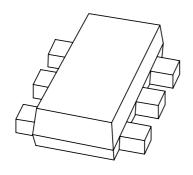
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Team Nexperia

DISCRETE SEMICONDUCTORS

DATA SHEET



PEMF2112 V PNP loadswitch

Product data sheet 2004 Jan 12



12 V PNP loadswitch

PEMF21

FEATURES

- Low V_{CEsat} transistor and resistor-equipped transistor in one package
- Very small 1.6 × 1.2 mm ultra thin package
- Reduced component count.

APPLICATIONS

- Line switches
- · Battery charger switches
- · Power supply switches
- Drive switches
- General purpose analog switches.

DESCRIPTION

Low V_{CEsat} PNP transistor and NPN resistor-equipped transistor in a SOT666 plastic package (see "Ordering information" for package details).

MARKING

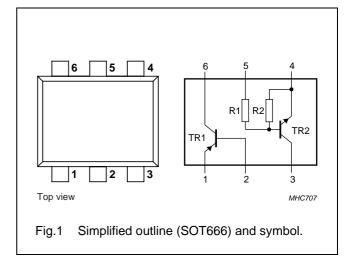
TYPE NUMBER	MARKING CODE
PEMF21	2F

QUICK REFERENCE DATA

SYMBOL	PARAMETER	TYP.	MAX.	UNIT		
TR1; PNP	TR1; PNP; low V _{CEsat} transistor					
V _{CEO}	collector-emitter voltage	_	-12	V		
I _C	collector current (DC)	_	-500	mA		
R _{CEsat}	equivalent on-resistance	_	500	mΩ		
TR2; NPN	TR2; NPN; resistor-equipped transistor					
V _{CEO}	collector-emitter voltage	_	50	V		
Io	output current (DC)	_	100	mA		
R1	bias resistor	10	_	kΩ		
R2	bias resistor	10	_	kΩ		

PINNING

PIN	DESCRIPTION	
1	emitter TR1	
2	base TR1	
3	collector TR2	
4	emitter TR2	
5	base TR2	
6	collector TR1	



ORDERING INFORMATION

TYPE NUMBER	PACKAGE				
TIFE NOWIBER	NAME	NAME DESCRIPTION VERSION			
PEMF21	_	 plastic surface mounted package; 6 leads 			

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LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 60134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT	
Transistor TR1						
V _{CBO}	collector-base voltage	open emitter	_	-15	V	
V_{CEO}	collector-emitter voltage	open base	_	-12	V	
V _{EBO}	emitter-base voltage	open collector	_	-6	V	
I _C	collector current (DC)		_	-500	mA	
I _{CM}	peak collector current		_	-1	А	
I _{BM}	peak base current		_	-100	mA	
P _{tot}	total power dissipation	T _{amb} = 25 °C; note 1	_	200	mW	
Transistor TR2			<u>.</u>		-	
V_{CBO}	collector-base voltage	open emitter	_	50	V	
V_{CEO}	collector-emitter voltage	open base	_	50	V	
V _{EBO}	emitter-base voltage	open collector	_	10	V	
Vi	input voltage					
	positive		_	+40	V	
	negative		_	-10	V	
I _O	output current (DC)		_	100	mA	
I _{CM}	peak collector current		_	100	mA	
P _{tot}	total power dissipation	T _{amb} = 25 °C; note 1	_	200	mW	
Per device						
P _{tot}	total power dissipation	T _{amb} = 25 °C; note 1	_	300	mW	
T _{stg}	storage temperature		-65	+150	°C	
Tj	junction temperature		_	150	°C	
T _{amb}	operating ambient temperature		-65	+150	°C	

Note

THERMAL CHARACTERISTICS

SYMBOL	PARAMETER	CONDITIONS	VALUE	UNIT
Per device				
R _{th(j-a)}	thermal resistance from junction to ambient	notes 1 and 2	416	K/W

Notes

- 1. Transistor mounted on an FR4 printed-circuit board.
- 2. Reflow soldering is the only recommended soldering method.

^{1.} Transistor mounted on an FR4 printed-circuit board.

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CHARACTERISTICS

 T_{amb} = 25 °C unless otherwise specified.

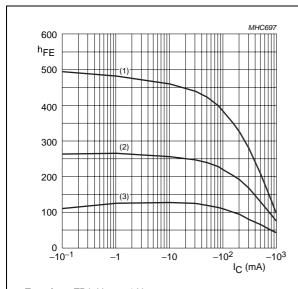
SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT	
Transistor	Transistor TR1						
I _{CBO}	collector-base cut-off current	$V_{CB} = -15 \text{ V}; I_E = 0$	_	_	-100	nA	
I _{EBO}	emitter-base cut-off current	$V_{EB} = -5 \text{ V}; I_{C} = 0$	_	_	-100	nA	
h _{FE}	DC current gain	$V_{CE} = -2 \text{ V}; I_{C} = -10 \text{ mA}$	200	_	_		
V _{CEsat}	collector-emitter saturation voltage	$I_C = -200 \text{ mA}; I_B = -10 \text{ mA}$	_	_	-250	mV	
R _{CEsat}	equivalent on-resistance	$I_C = -500 \text{ mA}$; $I_B = -50 \text{ mA}$; note 1	_	300	500	mΩ	
V _{BEsat}	base-emitter saturation voltage	$I_C = -500 \text{ mA}$; $I_B = -50 \text{ mA}$; note 1	-	_	-1.1	V	
V_{BEon}	base-emitter turn-on voltage	$V_{CE} = -2 \text{ V}; I_{C} = -100 \text{ mA}; \text{ note 1}$	_	_	-0.9	V	
f _T	transition frequency	$I_C = -100 \text{ mA}; V_{CE} = -5 \text{ V};$ f = 100 MHz	100	280	_	MHz	
C _c	collector capacitance	$V_{CB} = -10 \text{ V}; I_E = i_e = 0; f = 1 \text{ MHz}$	_	_	10	pF	
Transistor	TR2						
I _{CBO}	collector-base cut-off current	V _{CB} = 50 V; I _E = 0	_	_	100	nA	
I _{CEO}	collector-emitter cut-off current	$V_{CE} = 30 \text{ V}; I_{B} = 0$	-	_	1	μΑ	
I _{EBO}	emitter-base cut-off current	V _{EB} = 5 V; I _C = 0	-	_	400	μΑ	
h _{FE}	DC current gain	$V_{CE} = 5 \text{ V}; I_{C} = 5 \text{ mA}$	30	_	-		
V _{CEsat}	collector-emitter saturation voltage	$I_C = 10 \text{ mA}; I_B = 0.5 \text{ mA}$	_	_	300	mV	
V _{i(off)}	input-off voltage	$V_{CE} = 5 \text{ V}; I_{C} = 100 \mu\text{A}$	_	_	0.5	V	
V _{i(on)}	input-on voltage	$V_{CE} = 0.3 \text{ V}; I_{C} = 10 \text{ mA}$	3	_	-	V	
R1	input resistor		7	10	13	kΩ	
<u>R2</u> R1	resistor ratio		0.8	1	1.2		
C _c	collector capacitance	$V_{CB} = 10 \text{ V}; I_E = i_e = 0; f = 1 \text{ MHz}$	_	-	2.5	pF	

Note

1. Pulse test: $t_p \le 300~\mu s;~\delta \le 0.02.$

12 V PNP loadswitch

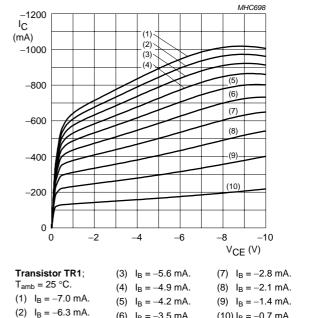
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Transistor TR1; $V_{CE} = -2 \ V$.

- (1) $T_{amb} = 150 \, ^{\circ}C$.
- (2) $T_{amb} = 25 \, ^{\circ}C$.
- (3) $T_{amb} = -55 \, ^{\circ}C$.

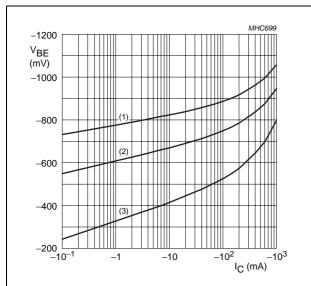
Fig.2 DC current gain as a function of collector current; typical values.



(6) $I_B = -3.5 \text{ mA}.$

(10) $I_B = -0.7 \text{ mA}$.

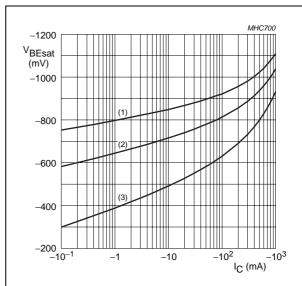
Collector current as a function of collector-emitter voltage; typical values.



Transistor TR1; $V_{CE} = -2 V$.

- (1) $T_{amb} = -55 \, ^{\circ}C$.
- (2) $T_{amb} = 25 \, ^{\circ}C$.
- (3) $T_{amb} = 150 \, ^{\circ}C$.

Fig.4 Base-emitter voltage as a function of collector current; typical values.



Transistor TR1; $I_C/I_B = 20$.

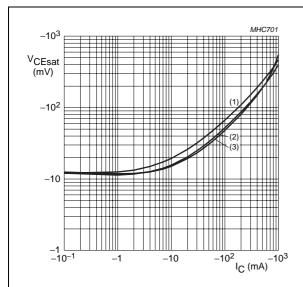
- (1) $T_{amb} = 150 \, ^{\circ}C$.
- (2) $T_{amb} = 25 \, ^{\circ}C$.
- (3) $T_{amb} = -55 \, ^{\circ}C$.

Fig.5 Base-emitter saturation voltage as a function of collector current; typical values.

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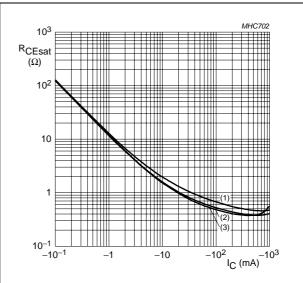
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Transistor TR1; $I_C/I_B = 20$.

- (1) $T_{amb} = 150 \, ^{\circ}C$.
- (2) $T_{amb} = 25 \, ^{\circ}C$.
- (3) $T_{amb} = -55 \, ^{\circ}C$.

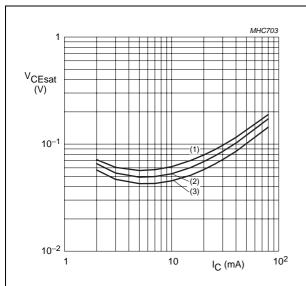
Fig.6 Collector-emitter saturation voltage as a function of collector current; typical values.



Transistor TR1; $I_C/I_B = 20$.

- (1) $T_{amb} = -55 \, ^{\circ}C$.
- (2) $T_{amb} = 25 \, ^{\circ}C$.
- (3) $T_{amb} = 150 \, ^{\circ}C$.

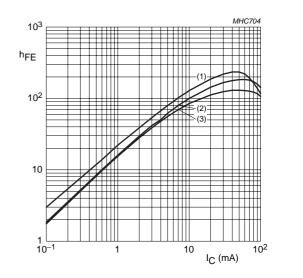
Fig.7 Equivalent on-resistance as a function of collector current; typical values.



Transistor TR2; $I_C/I_B = 20$.

- (1) $T_{amb} = 100 \, ^{\circ}C$.
- (2) $T_{amb} = 25 \, ^{\circ}C$.
- (3) $T_{amb} = -40 \, ^{\circ}C$.

Fig.8 Collector-emitter saturation voltage as a function of collector current; typical values.



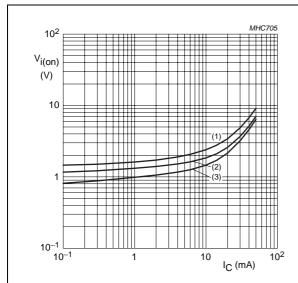
Transistor TR2; $V_{CE} = 5 \text{ V}$.

- (1) $T_{amb} = 150 \, ^{\circ}C$.
- (2) $T_{amb} = 25 \, ^{\circ}C$.
- (3) $T_{amb} = -40 \, ^{\circ}C$.

Fig.9 DC current gain as a function of collector current; typical values.

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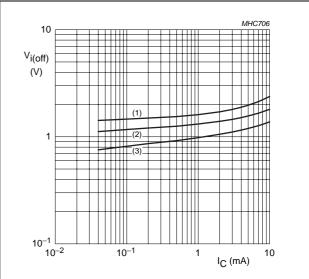
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Transistor TR2; $V_{CE} = 0.3 \text{ V}.$

- (1) $T_{amb} = -40 \, ^{\circ}C$.
- (2) $T_{amb} = 25 \, ^{\circ}C$.
- (3) $T_{amb} = 100 \, ^{\circ}C$.

Fig.10 Input-on voltage as a function of collector current; typical values.



Transistor TR2; $V_{CE} = 5 V$.

- (1) $T_{amb} = -40 \, ^{\circ}C$.
- (2) $T_{amb} = 25 \,^{\circ}C$.
- (3) $T_{amb} = 100 \, ^{\circ}C$.

Fig.11 Input-off voltage as a function of collector current; typical values.

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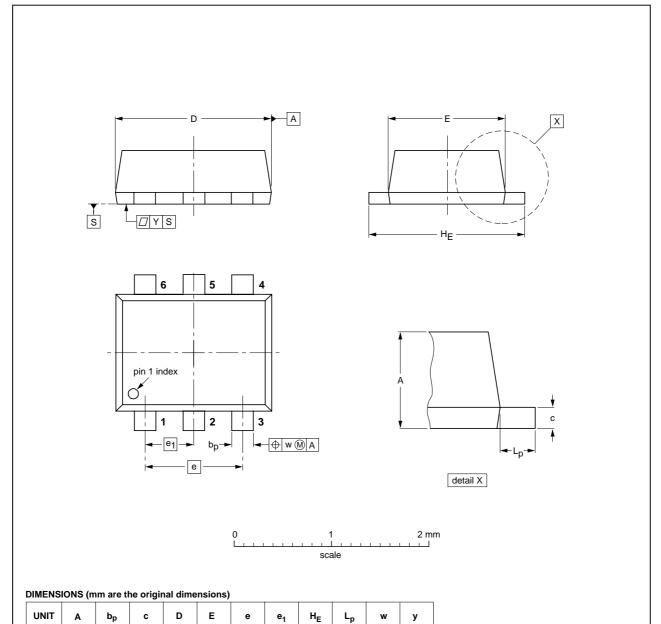
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PACKAGE OUTLINE

Plastic surface-mounted package; 6 leads

SOT666



OUTLINE	REFERENCES			EUROPEAN	ICCUE DATE	
VERSION	IEC	JEDEC	JEITA		PROJECTION	ISSUE DATE
SOT666						-04-11-08- 06-03-16

0.1

0.1

1.0

0.5

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0.6

0.5

0.27

0.17

0.18

1.5

1.1

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DATA SHEET STATUS

DOCUMENT STATUS ⁽¹⁾	PRODUCT STATUS ⁽²⁾	DEFINITION
Objective data sheet	Development	This document contains data from the objective specification for product development.
Preliminary data sheet	Qualification	This document contains data from the preliminary specification.
Product data sheet	Production	This document contains the product specification.

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NXP Semiconductors

Customer notification

This data sheet was changed to reflect the new company name NXP Semiconductors, including new legal definitions and disclaimers. No changes were made to the technical content, except for package outline drawings which were updated to the latest version.

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